SMD ▪ Top View LEDs
67-11-GHC-Y0U1V2A6E-2T8-AM

Features

- RoHS compliant.
- P-LCC-2 package.
- Colorless clear resin.
- Wide viewing angle 120°.
- Inner reflector and white package.
- Brightness: 450 to 1120 mcd at 20mA.
- Qualification according to AEC-Q101 rev C
- Precondition: Bases on JEDEC J-STD 020 Level 3.
- Useable in severe lead free processes with automotive reflow profile (IR reflow or wave soldering)

Applications

- Automotive backlighting or indicator: Dashboard, switch, audio and video equipments…etc.
- Backlight: LCD, switches, symbol, mobile phone and illuminated advertising.
- Display for indoor and outdoor application.
- Ideal for coupling into light guides.
- Substitution of traditional light.
- Optical indicator.
- General applications.

Device Selection Guide

Chip Materials	Emitted Color	Resin Color
InGaN	Brilliant Green	Water Clear

Absolute Maximum Ratings (Ta=25)

Parameter	Symbol	Rating	Unit
Reverse Voltage	V_R	5	V
Forward Current	I_F	30	mA
Peak Forward Current (Duty 1/10 @1KHz)	I_{FP}	100	mA
Power Dissipation	Pd	110	mW
Junction Temperature	T_j	125	
Operating Temperature	T_{opr}	-40 ~ +100	
Storage Temperature	T_{stg}	-40 ~ +110	
Thermal Resistance	Rth_{J-A}	250	K/W
	Rth_{J-S}	150	K/W
ESD (Classification acc. AEC Q101)	ESD_{HBM}	2000	V
	ESD_{MM}	200	V
Soldering Temperature	T_{sol}	Reflow Soldering: 260 for 30 sec. Hand Soldering : 350 for 3 sec.	

Electro-Optical Characteristics (Ta=25　)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Condition
Luminous Intensity	I_V	450	---	1120	mcd	I_F =20mA
Viewing Angle	$2\theta_{1/2}$	---	120	---	deg	I_F =20mA
Peak Wavelength	λp	---	518	---	nm	I_F =20mA
Dominant Wavelength	λd	520	---	535	nm	I_F =20mA
Spectrum Radiation Bandwidth	$\Delta\lambda$	---	35	---	nm	I_F =20mA
Forward Voltage	V_F	2.6	---	3.8	V	I_F =20mA
Reverse Current	I_R	---	---	50	µA	V_R =5V

Note:
1. Tolerance of Luminous Intensity: ±11%
2. Tolerance of Dominant Wavelength: ±1nm
3. Tolerance of Forward Voltage: ±0.1V

Bin Range of Luminous Intensity

Bin Code	Min.	Max.	Unit	Condition
U1	450	560	mcd	I_F =20mA
U2	560	710		
V1	710	900		
V2	900	1120		

Note:
Tolerance of Luminous Intensity: ±11%

Bin Range of Dominant Wavelength

Bin Code	Min.	Max.	Unit	Condition
X	520	525		
Y	525	530	nm	I_F =20mA
Z	530	535		

Note:
Tolerance of Dominant Wavelength: ±1nm

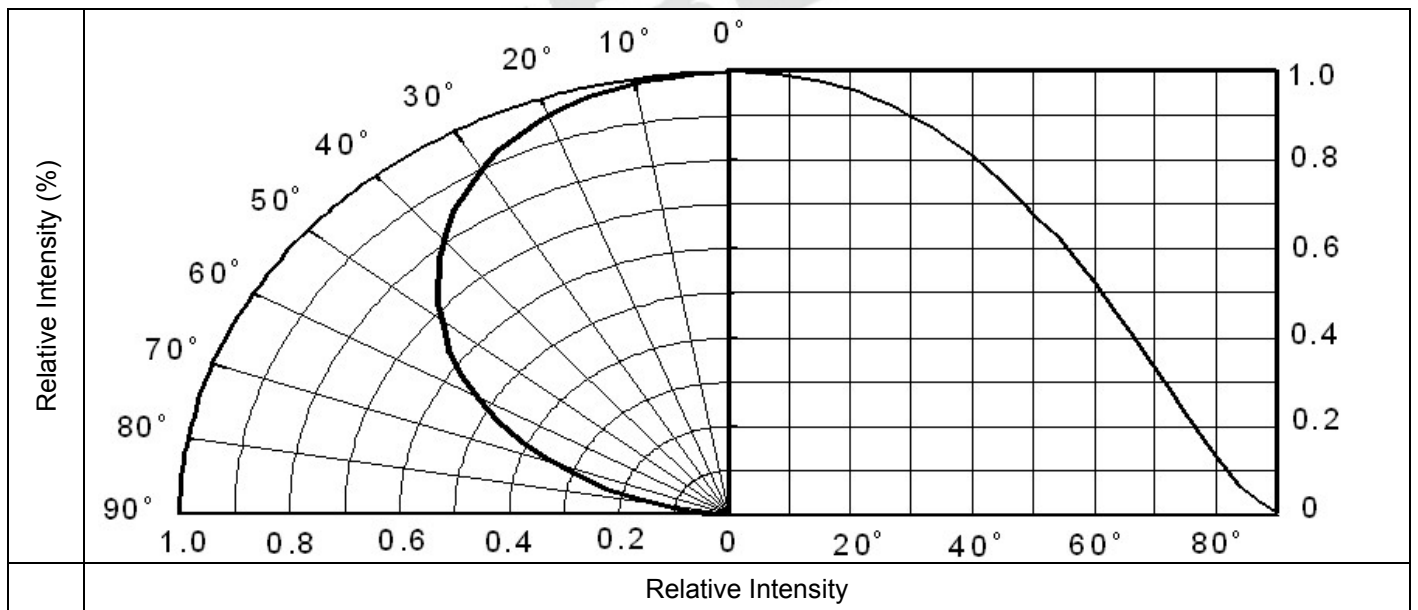LifecyclePhase: Approved   Expired Period: Forever
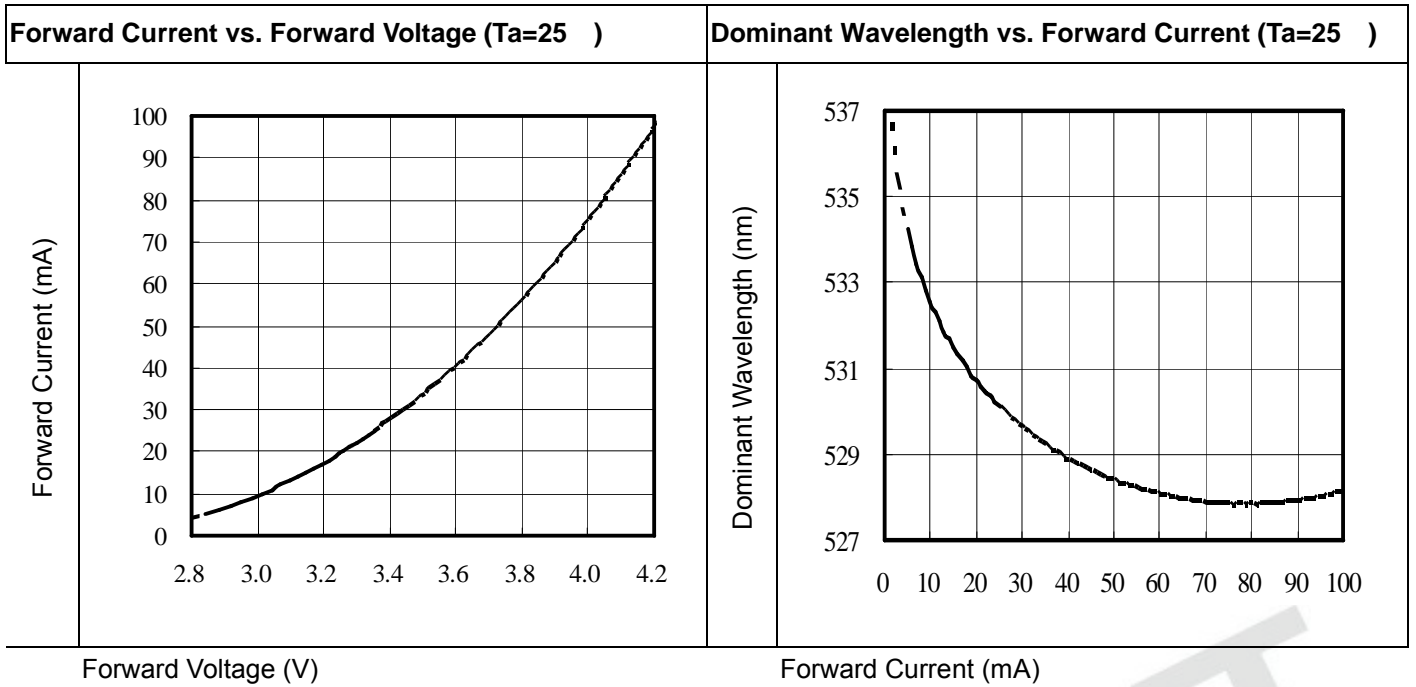
Typical Electro-Optical Characteristics Curves

Typical Curve of Spectral Distribution
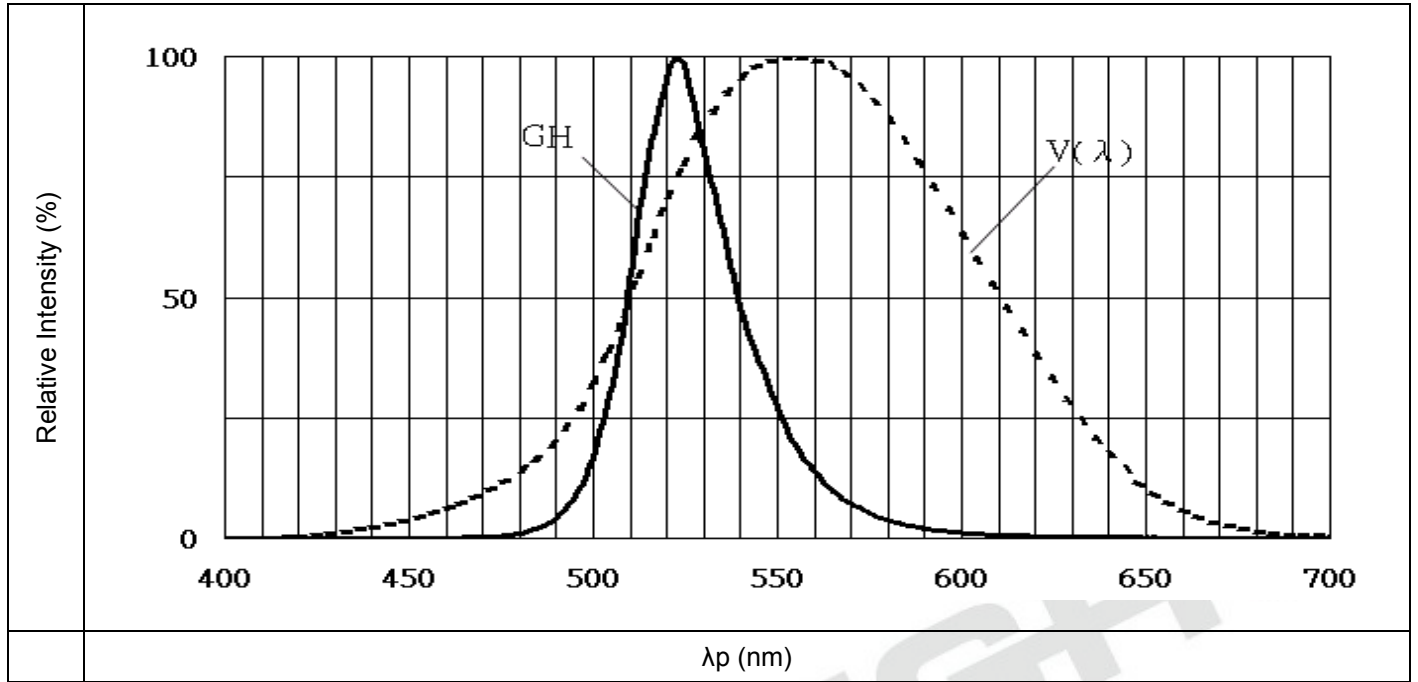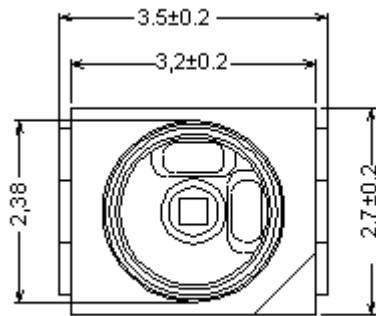

Note: V(λ)=Standard eye response curve; I_F =20mA

Diagram Characteristics of Radiation

Forward Current vs. Forward Voltage (Ta=25)

Forward Current (mA) vs. Forward Voltage (V)

Dominant Wavelength vs. Forward Current (Ta=25)

Dominant Wavelength (nm) vs. Forward Current (mA)

Relative Luminous Intensity vs. Forward Current (Ta=25)

Forward Current (mA) vs. Forward Current (mA)

Max. Permissible Forwarded Current (Ta=25)
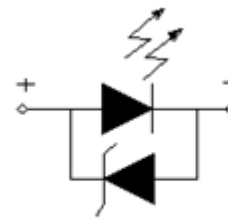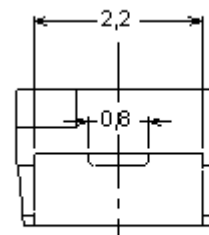
Dominant Wavelength (nm) vs. Temperature ( )
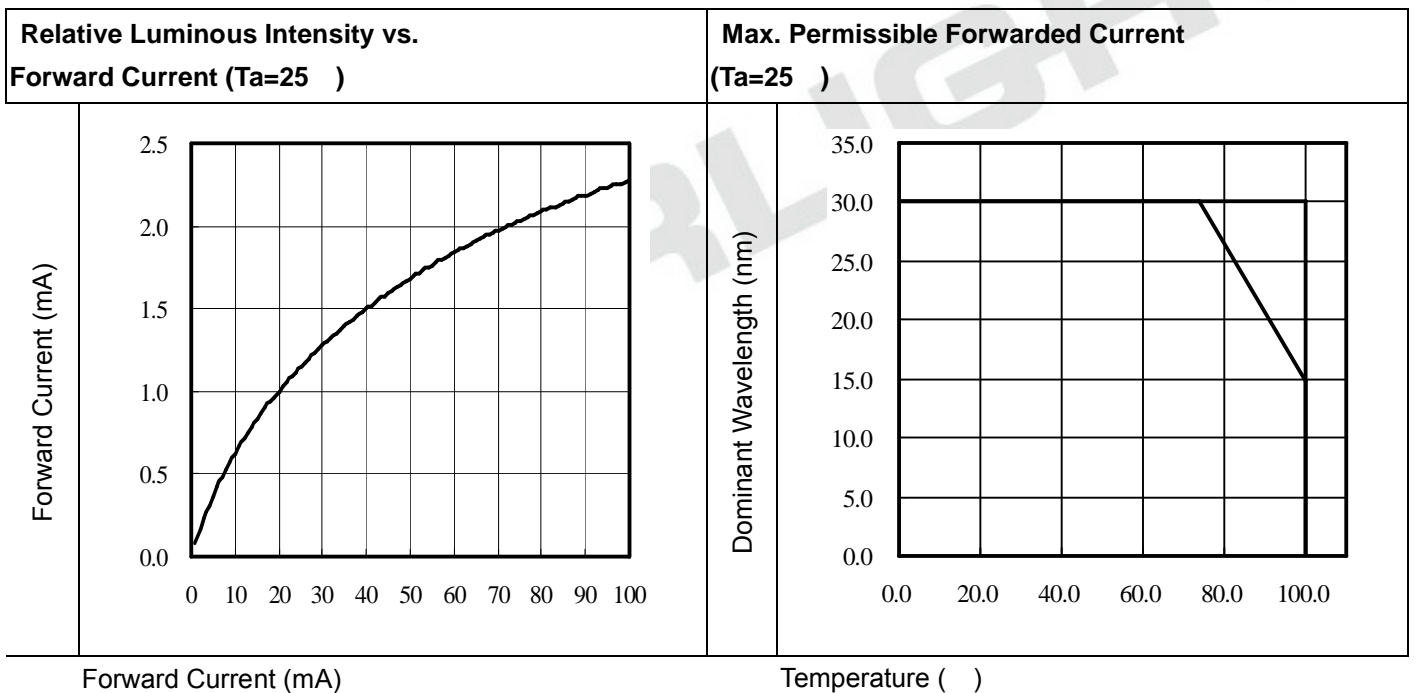
Package Dimension

Chip position

Polarity

Note: Tolerances unless mentioned ±0.1mm. Unit = mm

LifecyclePhase: Approved   Expired Period: Forever
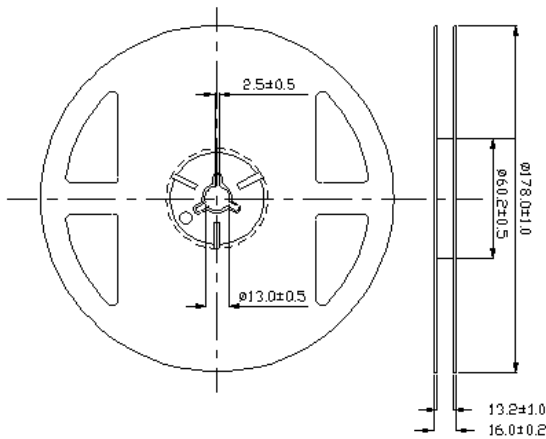
EVERLIGHT
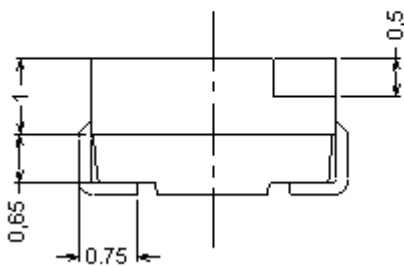
Moisture Resistant Packing Materials
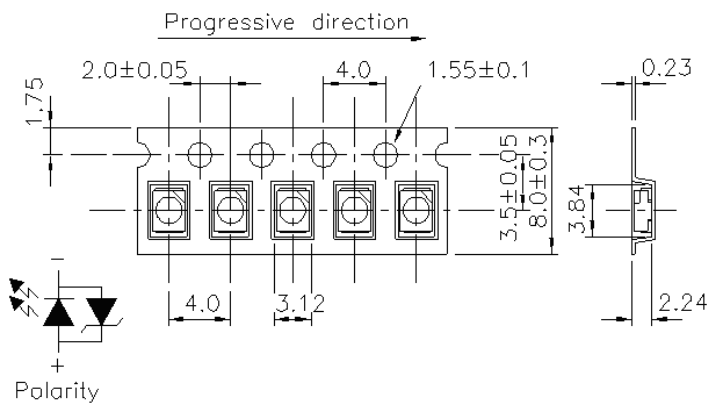
Label Explanation

- CPN: Customer's Product Number
- P/N: Product Number
- QTY: Packing Quantity
- CAT: Luminous Intensity Rank
- HUE: Dom. Wavelength Rank
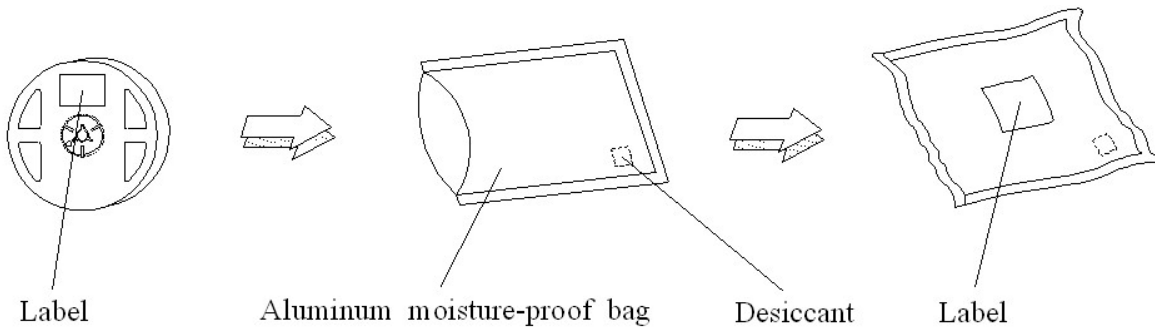- REF: Forward Voltage Rank
- LOT No: Lot Number

Reel Dimensions

Carrier Tape Dimensions: Loaded Quantity 2000 pcs Per Reel

Note: Tolerances unless mentioned ±0.1mm. Unit = mm

Lifecycle Phase: Approved   Expired Period: Forever

Moisture Resistant Packing Process

Label   Aluminum moisture-proof bag   Desiccant   Label
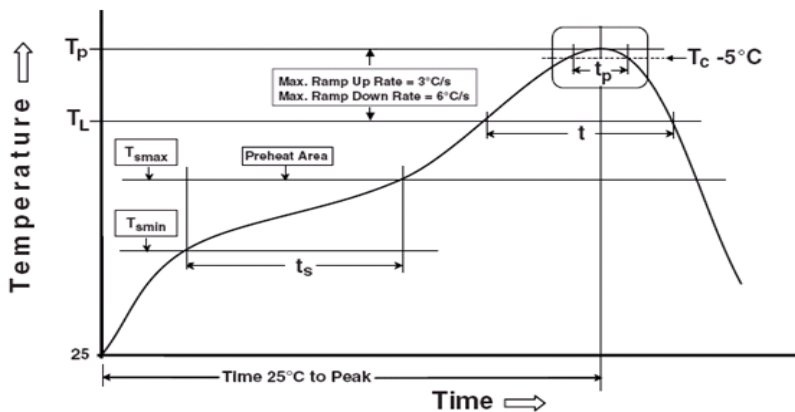
Note: Tolerances unless mentioned ±0.1mm. Unit = mm

Precautions for Use

1. Soldering Condition

1.1 (A) Maximum Body Case Temperature Profile for evaluation of Reflow Profile
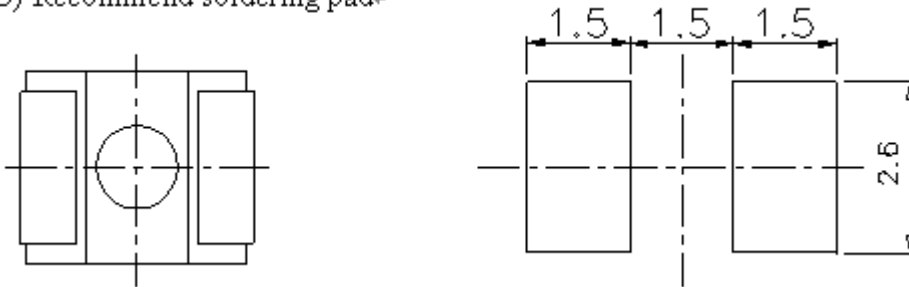

Note:

Preheat

Temperature min (T_{smin})	150 °C
Temperature max (T_{smax})	200°C
Time (T_{smin} to T_{smax}) (t_s)	60-120 seconds
Average ramp-up rate (T_{smax} to T_p)	3 °C/second max

Other

Liquidus Temperature (T_L)	217 °C
Time above Liquidus Temperature (t_L)	60-150 sec
Peak Temperature (T_P)	260°C
Time within 5 °C of Actual Peak Temperature: T_P - 5°C	30 s
Ramp- Down Rate from Peak Temperature	6°C /second max.
Time 25°C to peak temperature	8 minutes max.
Reflow times	3 times

All parameters are maximum body case temperature values and cannot be considered as a soldering profile. The body case temperature was measured by soldering a thermal couple to the soldering point of LEDs.

LifecyclePhase: Approved   Expired Period: Forever

(B) Recommend soldering pad

Note: Tolerances unless mentioned ±0.1mm. Unit = mm

2. Current limiting

A resistor should be used to limit current spikes that can be caused by voltage fluctuations. Otherwise damage could occur.

3. Storage

3.1 Moisture proof bag should only be opened immediately prior to usage.

3.2 Environment should be less than 30 and 60% RH when moisture proof bag is opened.

3.3 After opening the package MSL Conditions stated on page 1 of this spec should not be exceeded.

3.4 If the moisture sensitivity card indicates higher than acceptable moisture, the component should be baked at min. 60deg +/-5deg for 24 hours.

4. Iron Soldering

Hand soldering is not recommended for regular production. These guidelines are for rework only. Soldering iron tip should contact each terminal no more than 3 sec at 350 , using soldering iron with nominal power less than 25W. Allow min. 2 sec. between soldering intervals.

5. Usage

Do not exceed the values given in this specification.

Application Restrictions

High reliability applications such as military/aerospace, automotive safety/security systems, and medical equipment may require different product. If you have any concerns, please contact Everlight before using this product in your application. This specification guarantees the quality and performance of the product as an individual component. Do not use this product beyond the specification described in this document.